

ABS2U THRU ABS10U
SINGLE PHASE 1.0AMP SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

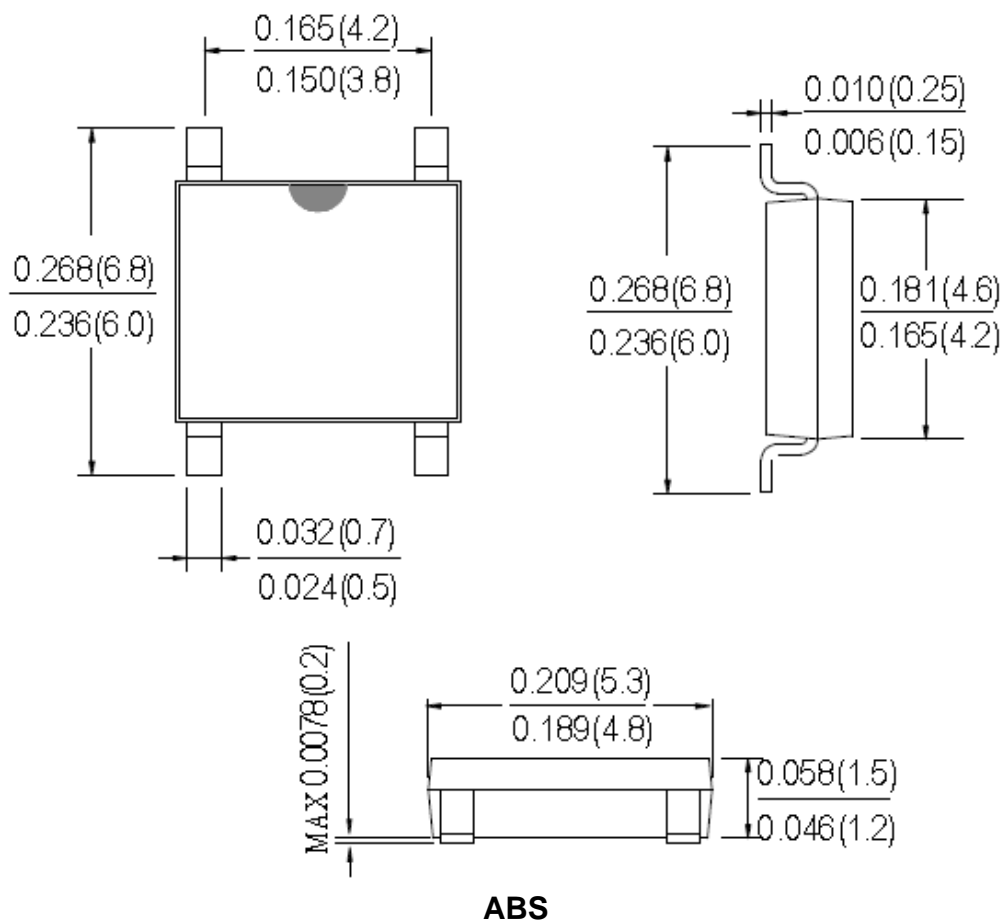
Features:

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0

Mechanical Data:

- Case: SOPA-4, Molded plastic ABS
- Terminals: Plated leads solderable per MIL-STD-202, Method 208
- Polarity: Polarity symbols marked on case
- Mounting Position: Any

Mechanical Dimensions: In Inches/mm



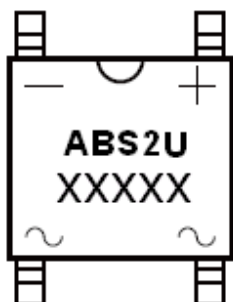


ABS2U THRU ABS10U

Technical Data
Data Sheet N1812, Rev. -

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Marking Diagram:



Where XXXXX is YYWWL

ABS2U = Part Name
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
ABS2U THRU ABS10U	ABS (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.



Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified

Single Phase half wave 60Hz, resistive or inductive load. For capacitive load current derate by 20%.

Characteristic	Symbol	ABS2U	ABS4U	ABS6U	ABS8U	ABS10U	Units
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	140	280	420	560	700	
Maximum DC blocking voltage	V_{DC}	200	400	600	800	1000	
Average Rectified Output Current @ $T_A = 30^\circ C$	I_o	1.0					V
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	35					A
Forward voltage per element @ $I_F = 1.0A$	V_F	1.1					V
Maximum DC reverse current at rated DC blocking voltage $T_A = 25^\circ C$ $T_A = 125^\circ C$	I_R	5 500					μA
Typical thermal resistance per leg (Note 1)	$R_{\theta JL}$ $R_{\theta JA}$	62.5 25					$^\circ C/W$
Operating and storage temperature range	T_J, T_{STG}	-55 to +150					$^\circ C$

Note: 1. Thermal resistance form junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2"(5X5mm) copper pads.

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

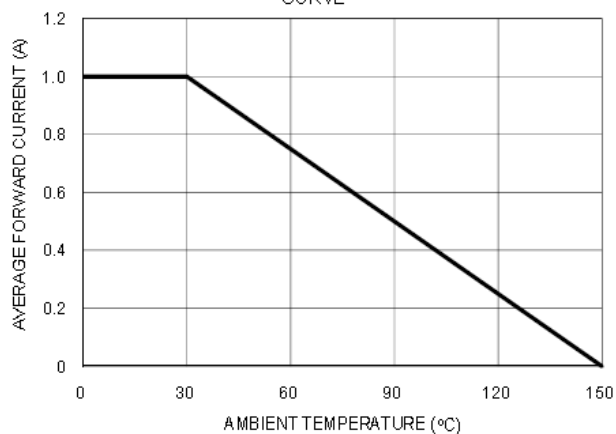


FIG. 2 TYPICAL FORWARD CHARACTERISTIC

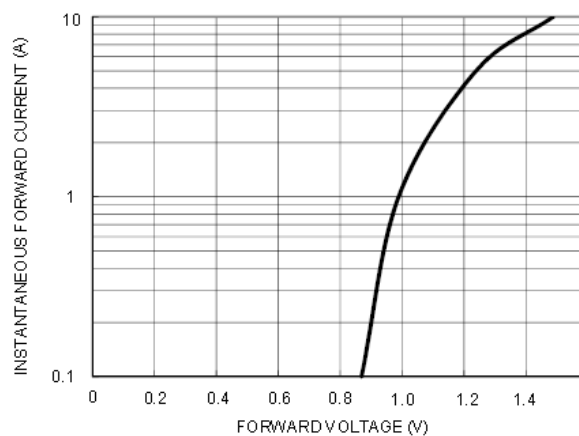


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

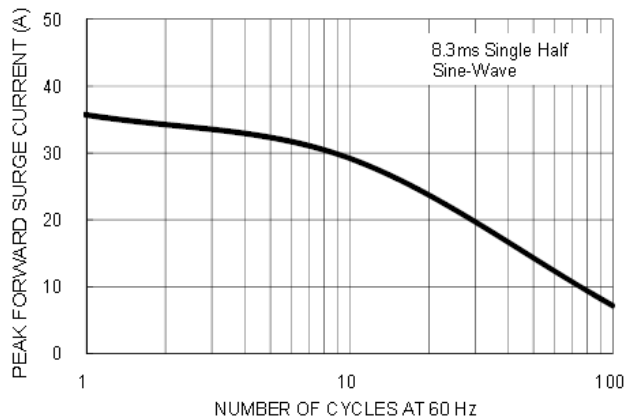
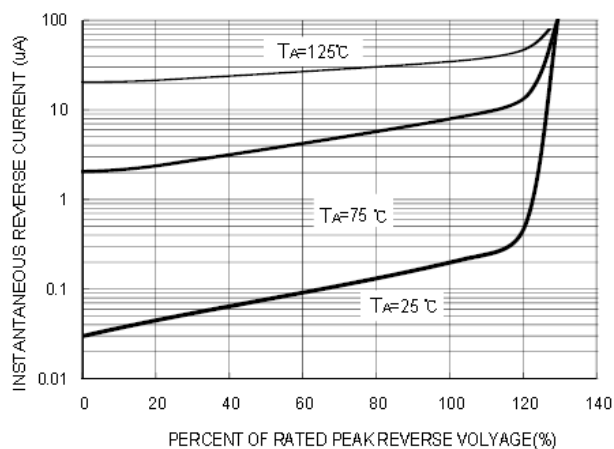


FIG. 4 TYPICAL REVERSE CHARACTERISTICS





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ABS10U**

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